

XN04602

Silicon NPN epitaxial planar transistor (Tr1)
 Silicon PNP epitaxial planar transistor (Tr2)

For general amplification

■ Features

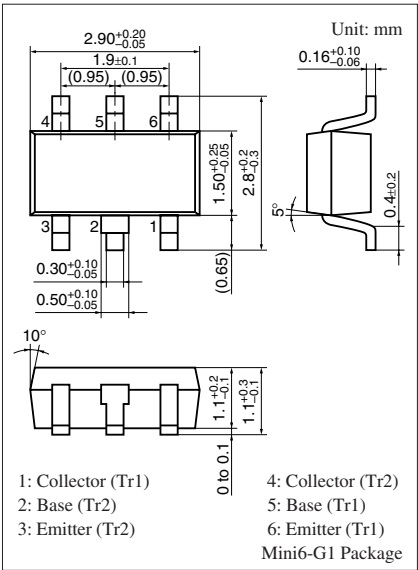
- Two elements incorporated into one package (Each transistor is separated)
- Reduction of the mounting area and assembly cost by one half

■ Basic Part Number of Element

- 2SA0719 (2SA719) + 2SC1317

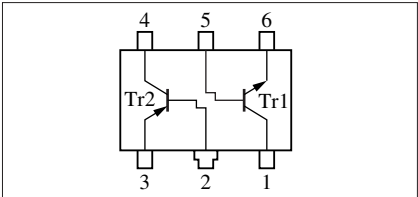
■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

| | Parameter | Symbol | Rating | Unit |
|---------|------------------------------|-----------|-------------|------------------|
| Tr1 | Collector to base voltage | V_{CBO} | 60 | V |
| | Collector to emitter voltage | V_{CEO} | 50 | V |
| | Emitter to base voltage | V_{EBO} | 5 | V |
| | Collector current | I_C | 0.5 | A |
| | Peak collector current | I_{CP} | 1 | A |
| Tr2 | Collector to base voltage | V_{CBO} | -60 | V |
| | Collector to emitter voltage | V_{CEO} | -50 | V |
| | Emitter to base voltage | V_{EBO} | -5 | V |
| | Collector current | I_C | -0.5 | A |
| | Peak collector current | I_{CP} | -1 | A |
| Overall | Total power dissipation | P_T | 300 | mW |
| | Junction temperature | T_j | 150 | $^\circ\text{C}$ |
| | Storage temperature | T_{stg} | -55 to +150 | $^\circ\text{C}$ |



Marking Symbol: 4A

Internal Connection



Note) The part number in the parenthesis shows conventional part number.

■ Electrical Characteristics $T_a = 25^\circ\text{C} \pm 3^\circ\text{C}$

• Tr1

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|---|----------------------|--|-----|------|-----|---------------|
| Collector to base voltage | V_{CBO} | $I_{\text{C}} = 10\ \mu\text{A}, I_{\text{E}} = 0$ | 60 | | | V |
| Collector to emitter voltage | V_{CEO} | $I_{\text{C}} = 10\ \text{mA}, I_{\text{B}} = 0$ | 50 | | | |
| Emitter to base voltage | V_{EBO} | $I_{\text{E}} = 10\ \mu\text{A}, I_{\text{C}} = 0$ | 5 | | | V |
| Collector cutoff current | I_{CBO} | $V_{\text{CB}} = 20\ \text{V}, I_{\text{E}} = 0$ | | | 0.1 | μA |
| DC current gain * | h_{FE1} | $V_{\text{CE}} = 10\ \text{V}, I_{\text{C}} = 150\ \text{mA}$ | 85 | | 340 | — |
| | h_{FE2} | $V_{\text{CE}} = 10\ \text{V}, I_{\text{C}} = 500\ \text{mA}$ | 40 | | | |
| Collector to emitter saturation voltage * | $V_{\text{CE(sat)}}$ | $I_{\text{C}} = 300\ \text{mA}, I_{\text{B}} = 30\ \text{mA}$ | | 0.35 | 0.6 | V |
| Collector output capacitance | C_{ob} | $V_{\text{CB}} = 10\ \text{V}, I_{\text{E}} = 0, f = 1\ \text{MHz}$ | | 6 | 15 | pF |
| Gain bandwidth product | f_{T} | $V_{\text{CB}} = 10\ \text{V}, I_{\text{E}} = -50\ \text{mA}, f = 200\ \text{MHz}$ | | 200 | | MHz |

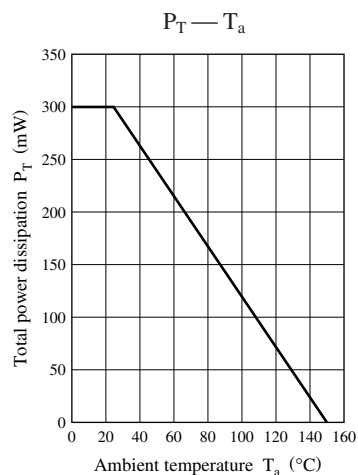
Note) *: Pulse measurement

• Tr2

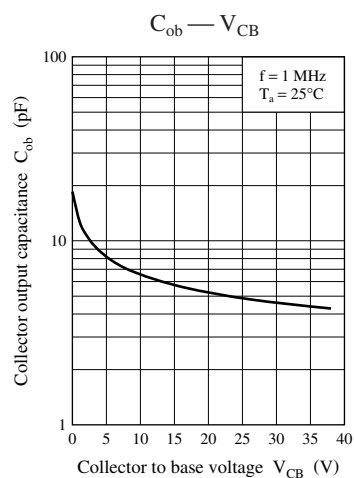
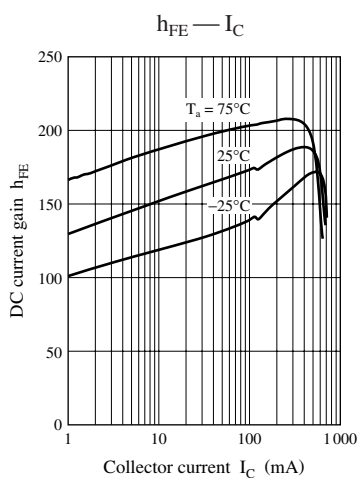
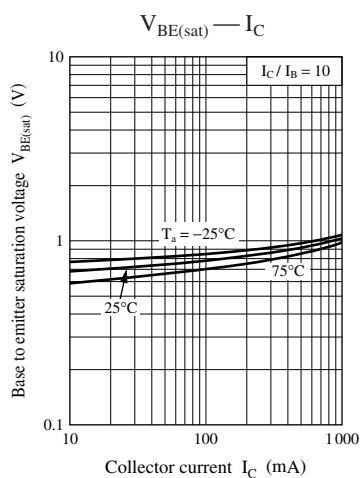
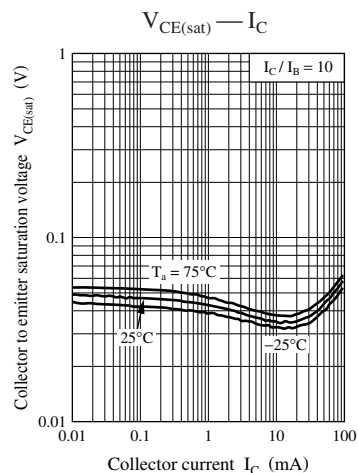
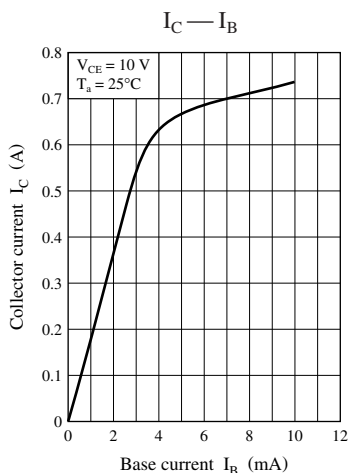
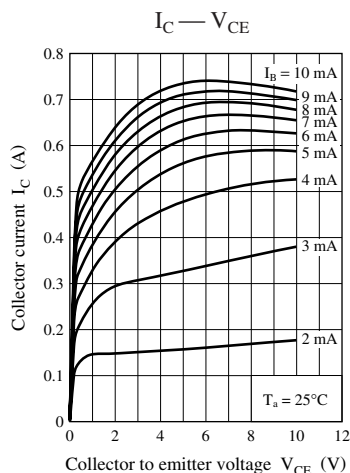
| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|---|----------------------|--|-----|-------|------|---------------|
| Collector to base voltage | V_{CBO} | $I_{\text{C}} = -10\ \mu\text{A}, I_{\text{E}} = 0$ | -60 | | | V |
| Collector to emitter voltage | V_{CEO} | $I_{\text{C}} = -10\ \text{mA}, I_{\text{B}} = 0$ | -50 | | | |
| Emitter to base voltage | V_{EBO} | $I_{\text{E}} = -10\ \mu\text{A}, I_{\text{C}} = 0$ | -5 | | | V |
| Collector cutoff current | I_{CBO} | $V_{\text{CB}} = -20\ \text{V}, I_{\text{E}} = 0$ | | | -0.1 | μA |
| DC current gain * | h_{FE1} | $V_{\text{CE}} = -10\ \text{V}, I_{\text{C}} = -150\ \text{mA}$ | 85 | | 340 | — |
| | h_{FE2} | $V_{\text{CE}} = -10\ \text{V}, I_{\text{C}} = -500\ \text{mA}$ | 40 | | | |
| Collector to emitter saturation voltage * | $V_{\text{CE(sat)}}$ | $I_{\text{C}} = -300\ \text{mA}, I_{\text{B}} = -30\ \text{mA}$ | | -0.35 | -0.6 | V |
| Base to emitter saturation voltage * | $V_{\text{BE(sat)}}$ | $I_{\text{C}} = -300\ \text{mA}, I_{\text{B}} = -30\ \text{mA}$ | | -1.1 | -1.5 | V |
| Collector output capacitance | C_{ob} | $V_{\text{CB}} = -10\ \text{V}, I_{\text{E}} = 0, f = 1\ \text{MHz}$ | | 6 | 15 | pF |
| Gain bandwidth product | f_{T} | $V_{\text{CB}} = -10\ \text{V}, I_{\text{E}} = 50\ \text{mA}, f = 200\ \text{MHz}$ | | 200 | | MHz |

Note) *: Pulse measurement

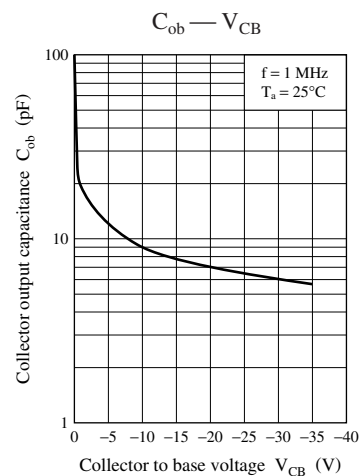
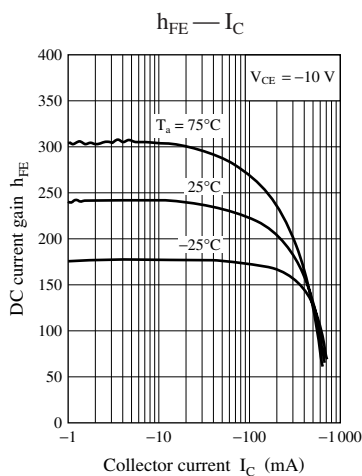
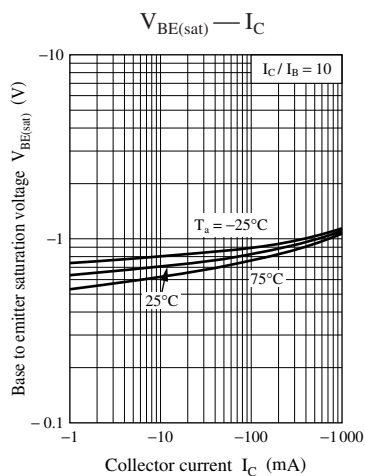
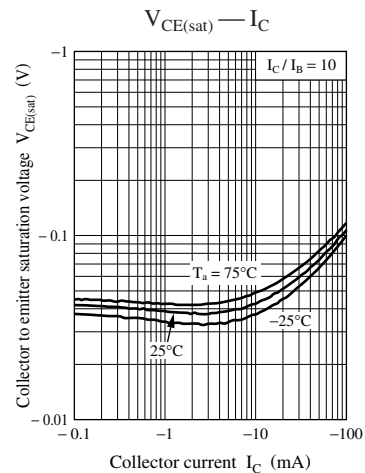
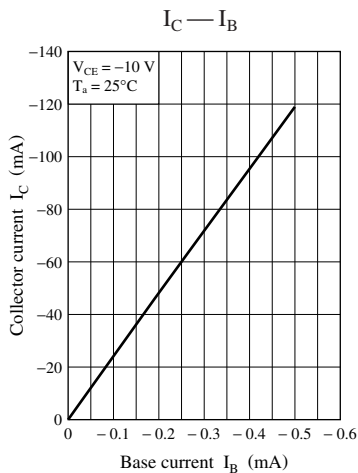
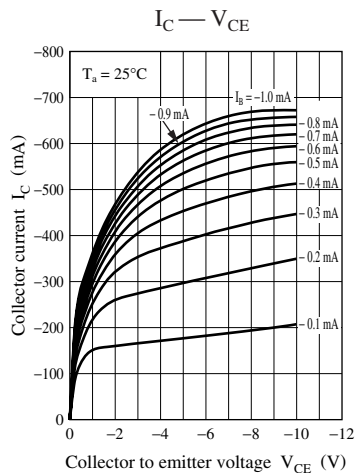
Common characteristics chart



Characteristics charts of Tr1



Characteristics charts of Tr2



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